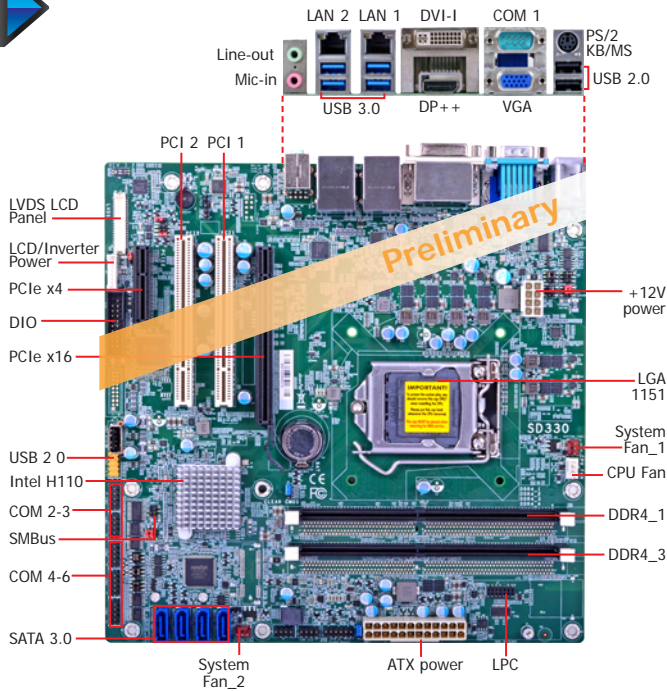


MB-SD330-H110

Desktop

H110



Preliminary

Features

- 2 DDR4 DIMM up to 32GB
- Four display ports: VGA, LVDS, DVI-I, DP++ Supports two independent displays
- DP++ resolution up to 4096x2304 @ 60Hz Dual Channel LVDS resolution up to 1920x1200 @ 60Hz
- Multiple expansion: 1 PCIe x16, 1 PCIe x4, 2 PCI, 1 LPC
- Rich I/O: 2 Intel GbE, 6 COM, 4 USB 3.0, 6 USB 2.0
- LPC EXT-RS232/485 module supports 4 COM ports



2 Extension Modules for Additional 4 COM Ports (via the LPC connector)

Proprietary Technology



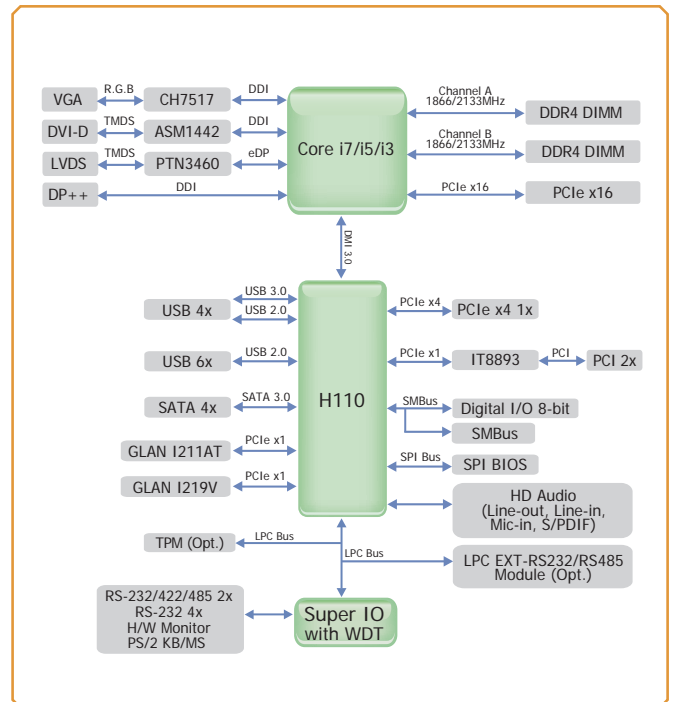
Ordering Information

Model Name	Memory	GbE	RS-232/422/485	RS-232	USB 3.0	USB 2.0	Power	Thermal	Temp.
MB-SD330-H110	2 DIMM	2	1	5	4	6	24-pin ATX	Active	0 to 60°C

Mechanical Drawing



Block Diagram



Specifications

SYSTEM	Processor	6th Generation Intel® Core™ Processors, LGA 1151 Socket Intel® Core™ i7-6700 Processor, Quad Core, 8M Cache, 3.4GHz (4.0GHz), 65W Intel® Core™ i7-6700TE Processor, Quad Core, 8M Cache, 2.4GHz (3.4GHz), 35W Intel® Core™ i5-6500 Processor, Quad Core, 6M Cache, 3.2GHz (3.6GHz), 65W Intel® Core™ i5-6500TE Processor, Quad Core, 6M Cache, 2.3GHz (3.3GHz), 35W Intel® Core™ i3-6100 Processor, Dual Core, 3M Cache, 3.7GHz, 47W Intel® Core™ i3-6100TE Processor, Dual Core, 4M Cache, 2.7GHz, 35W Intel® Pentium® Processor G4400, Dual Core, 3M Cache, 3.3GHz, 47W Intel® Pentium® Processor G4400TE, Dual Core, 3M Cache, 2.4GHz, 35W	
	Chipset	Intel® H110	
	Memory	Two 288-pin DIMM up to 32GB	Dual Channel DDR4 1866/2133MHz
	BIOS	Insyde SPI 128Mbit	
GRAPHICS	Controller	Intel® HD Gen 9 Graphics	
	Feature	OpenGL 5.0, DirectX 12, OpenCL 2.1 HW Decode: AVC/H.264, MPEG2, VC1/WMV9, JPEG/MJPEG, HEVC/H265, VP8, VP9 HW Encode: MPEG2, AVC/H264, JPEG, HEVC/H265, VP8, VP9	
	Display	1 x VGA 1 x LVDS 1 x DVI-I (DVI-D signal) 1 x DP++	VGA: resolution up to 1920x1200 @ 60Hz LVDS: dual channel, resolution up to 1920x1200 @ 60Hz DVI-I: resolution up to 1920x1200 @ 60Hz DP++: resolution up to 4096x2304 @ 60Hz
	Dual Displays	VGA + LVDS VGA + DVI-I (DVI-D signal) VGA + DP++	LVDS + DVI-I (DVI-D signal) LVDS + DP++ DVI-I (DVI-D signal) + DP++
EXPANSION	Interface	1 x PCIe x16 (Gen 3) 1 x PCIe x4 (Gen 2) 2 x PCI	
AUDIO	Audio Codec	Realtek ALC888S-VD2-GR	
ETHERNET	Controller	1 x Intel® I211AT PCIe (10/100/1000Mbps) 1 x Intel® I219V PCIe (10/100/1000Mbps)	
REAR I/O	Ethernet	2 x GbE (RJ-45)	
	USB	4 x USB 3.0 2 x USB 2.0	
	Serial	1 x RS-232/422/485 (RS-232 w/ power) (DB-9)	
	PS/2	1 x PS/2 (mini-DIN-6)	
	Display	1 x VGA 1 x DVI-I (DVI-D signal) 1 x DP++	
	Audio	1 x Line-out 1 x Mic-in 1 x Line-in (available upon request)	
	INTERNAL I/O	Serial	1 x RS-232/422/485 (RS-232 w/ power) (2.54mm pitch) 4 x RS-232 (2.54mm pitch)
	USB	4 x USB 2.0 (2.54mm pitch) or 2 x USB 2.0 (2.54mm pitch) + 1 x Vertical USB 2.0 (type A) (available upon request)	
	Audio	1 x S/PDIF	
	SATA	4 x SATA 3.0 (up to 6Gb/s)	
	DIO	1 x 8-bit DIO	
	LPC	1 x LPC (supports LPC EXT-RS232/RS485 module)	
	SMBus	1 x SMBus	
WATCHDOG TIMER	Output & Interval	System Reset, Programmable via Software from 1 to 255 Seconds	
SECURITY	TPM	Available Upon Request	
POWER	Type	ATX	
	Connector	8-pin ATX 12V power	24-pin ATX power
	Consumption	TBD	
	RTC Battery	CR2032 Coin Cell	
OS SUPPORT		Windows 7 (WES7) 32/64-bit Windows 8.1 (64-bit) Windows 10 IoT Enterprise 64-bit	
ENVIRONMENT	Temperature	Operating: 0 to 60°C	Storage: -40 to 85°C
	Humidity	Operating: 5 to 90% RH	Storage: 5 to 90% RH
	MTBF	365,364 hrs @ 25°C; 207,523 hrs @ 45°C; 131,395 hrs @ 60°C Calculation Model: Telcordia Issue 2, Method Case 3 Environment: GB, GC – Ground Benign, Controlled	
	MECHANICAL	Dimensions	microATX form factor 244mm (9.6") x 244mm (9.6")
	Height	PCB: TBD Top Side: TBD, Bottom Side: TBD	

Packing List

• 1 MB- SD330-H110 motherboard	
• 1 COM port cable (Length: 260mm)	332-054028-004G
• 1 Serial ATA data cable (Length: 500mm)	332-553001-005G
• 1 I/O shield	A49-SD3300-000G
• 1 DVD	

Optional Items

• USB port cable (Length: 350/398mm)	332-253010-026G
• COM port cable (Length: 260mm)	332-054028-004G
• Serial ATA data cable (Length: 500mm)	332-553001-005G
• Thermal solution (For 35W, Height: 37.3mm)	A71-103004-000G
• Thermal solution (For 65W, Height: 72.8mm)	552-200049-000G
• LPC EXT-RS232 module (4 x RS232 ports)	770-EXTRS1-000G
• LPC EXT-RS485 module (4 x RS485 ports)	770-EXTRS1-100G